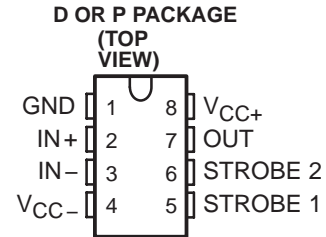


LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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- Fast Response Times
- Improved Gain and Accuracy
- Fanout to 10 Series 54/74 TTL Loads
- Strobe Capability
- Short-Circuit and Surge Protection
- Designed to Be Interchangeable With National Semiconductor LM306



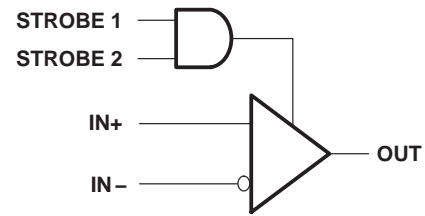
description

The LM306 is a high-speed voltage comparator with differential inputs, a low-impedance high-sink-current (100 mA) output, and two strobe inputs. This device detects low-level analog or digital signals and can drive digital logic or lamps and relays directly. Short-circuit protection and surge-current limiting is provided.

A low-level input at either strobe causes the output to remain high regardless of the differential input. When both strobe inputs are either open or at a high logic level, the output voltage is controlled by the differential input voltage. The circuit will operate with any negative supply voltage between -3 V and -12 V with little difference in performance.

The LM306 is characterized for operation from 0°C to 70°C .

functional block diagram



AVAILABLE OPTIONS

T_A	$V_{IO\max}$ at 25°C	PACKAGE	
		SMALL OUTLINE (D)	PLASTIC DIP (P)
0°C to 70°C	5 mV	LM306D	LM306P

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.


**TEXAS
INSTRUMENTS**

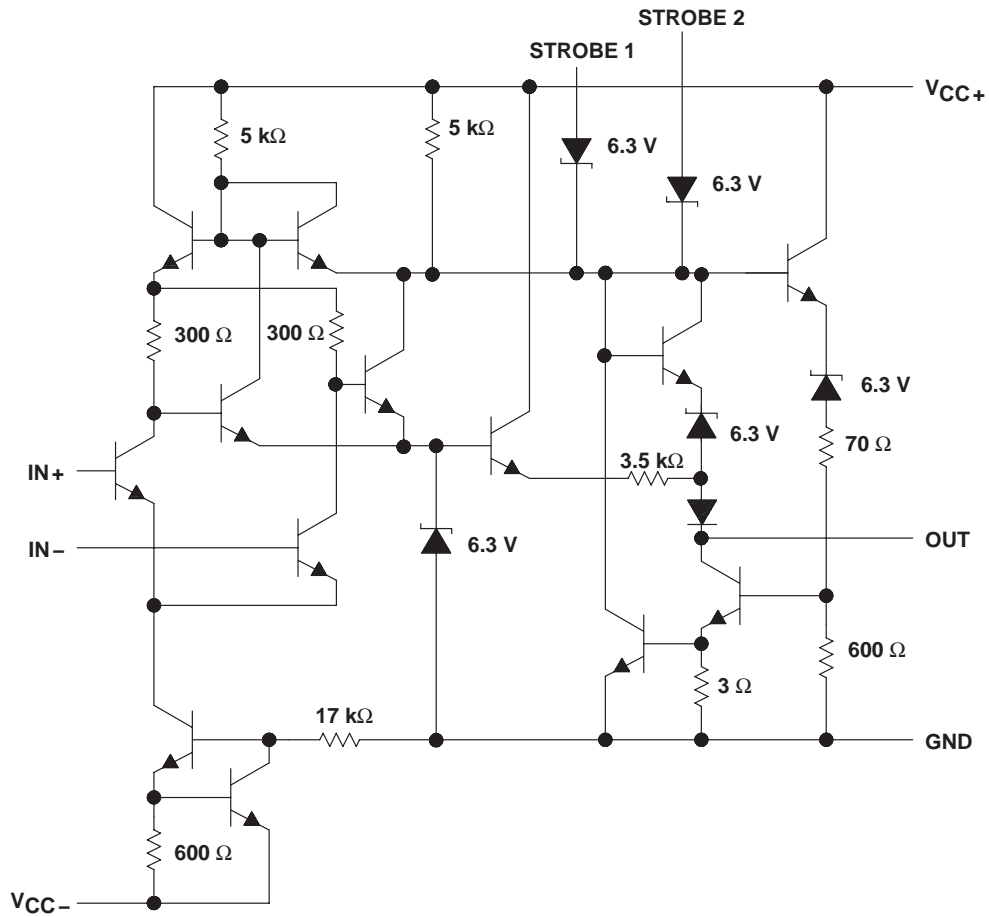
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LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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schematic



Resistor values are nominal.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC+} (see Note 1)	15 V
Supply voltage, V_{CC-} (see Note 1)	-15 V
Differential input voltage, V_{ID} (see Note 2)	± 5 V
Input voltage, V_I (either input, see Notes 1 and 3)	± 7 V
Strobe voltage range (see Note 1)	0 V to V_{CC+}
Output voltage, V_O (see Note 1)	24 V
Voltage from output to V_{CC-}	30 V
Duration of output short circuit to ground (see Note 4)	10 s
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages and the voltage from the output to V_{CC-} , are with respect to the network ground.
 2. Differential voltages are at $IN+$ with respect to $IN-$.
 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 7 V, whichever is less.
 4. The output may be shorted to ground or either power supply.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR	DERATE ABOVE T_A	$T_A = 70^\circ\text{C}$ POWER RATING
D	600 mW	5.8 mW/ $^\circ\text{C}$	46°C	464 mW
P	600 mW	8.0 mW/ $^\circ\text{C}$	75°C	600 mW



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electrical characteristics at specified free-air temperature, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -3\text{ V}$ to -12 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	T_A ‡	MIN	TYP	MAX	UNIT	
V_{IO}	Input offset voltage	$R_S \leq 200\ \Omega$	25°C		1.6§	5	mV	
			Full range			6.5		
αV_{IO}	Average temperature coefficient of input offset voltage	$R_S = 50\ \Omega$, See Note 5	Full range		5	20	$\mu\text{V}/^\circ\text{C}$	
I_{IO}	Input offset current	See Note 5	25°C		1.8	5	μA	
			MIN		1	7.5		
			MAX		0.5	5		
αI_{IO}	Average temperature coefficient of input offset current	See Note 5	MIN to 25°C		24	100	$\text{nA}/^\circ\text{C}$	
			25°C to MAX		15	50		
I_{IB}	Input bias current	$V_O = 0.5\text{ V}$ to 5 V	MIN to 25°C			40	μA	
			25°C to MAX		16	25		
$I_{IL(S)}$	Low-level strobe current	$V(\text{strobe}) = 0.4\text{ V}$	Full range		-1.7	-3.2	mA	
$V_{IH(S)}$	High-level strobe voltage		Full range	2.2			V	
$V_{IL(S)}$	Low-level strobe voltage		Full range			0.9	V	
V_{ICR}	Common-mode input voltage range	$V_{CC-} = -7\text{ V}$ to -12 V	Full range	± 5			V	
V_{ID}	Differential input voltage range		Full range	± 5			V	
A_{VD}	Large-signal differential voltage amplification	$V_O = 0.5\text{ V}$ to 5 V , No load	25°C		40		V/mV	
V_{OH}	High-level output voltage	$I_{OH} = -400\ \mu\text{A}$ $V_{ID} = 8\text{ mV}$	Full range	2.5		5.5	V	
V_{OL}	Low-level output voltage	$I_{OL} = 100\text{ mA}$ $V_{ID} = -7\text{ mV}$	25°C		0.8	2	V	
		$I_{OL} = 50\text{ mA}$ $V_{ID} = -7\text{ mV}$	Full range			1		
		$I_{OL} = 16\text{ mA}$ $V_{ID} = -8\text{ mV}$	Full range			0.4		
I_{OH}	High-level output voltage	$V_{OH} = 8\text{ V}$ to 24 V	$V_{ID} = 7\text{ mV}$	MIN to 25°C		0.02	2	μA
			$V_{ID} = 8\text{ mV}$	25°C to MAX			100	
I_{CC+}	Supply current from V_{CC+}	$V_{ID} = -5\text{ mV}$, No load	Full range		6.6	10	mA	
I_{CC-}	Supply current from V_{CC-}	No load	Full range		-1.9	-3.6	mA	

† Unless otherwise noted, all characteristics are measured with both strobes open.

‡ Full range is 0°C to 70°C. MIN is 0°C. MAX is 70°C.

§ This typical value is at $V_{CC+} = 12\text{ V}$, $V_{CC-} = -6\text{ V}$.

NOTE 5: The offset voltages and offset currents given are the maximum values required to drive the output down to the low range (V_{OL}) or up to the high range (V_{OH}). These parameters actually define an error band and take into account the worst-case effects of voltage gain and input impedance.

switching characteristics, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -6\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS†	MIN	TYP	MAX	UNIT
Response time, low-to-high-level output	$R_L = 390\ \Omega$ to 5 V , $C_L = 15\text{ pF}$, See Note 6		28	40	ns

† All characteristics are measured with both strobes open.

NOTE 6: The response time specified is for a 100-mV input step with 5-mV overdrive and is the interval between the input step function and the instant when the output crosses 1.4 V.



TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
I_{IB}	Input bias current	vs Free-air temperature	1
I_{IO}	Input offset current	vs Free-air temperature	2
V_{OH}	High-level output voltage	vs Free-air temperature	3
V_{OL}	Low-level output voltage	vs Free-air temperature	4
V_O	Output voltage	vs Differential input voltage	5
I_O	Output current	vs Differential input voltage	6
A_{VD}	Large-signal differential voltage amplification	vs Free-air temperature	7
I_{OS}	Short-circuit output current	vs Free-air temperature	8
	Output response	vs Time	9, 10
I_{CC+}	Positive supply current	vs Positive supply voltage	11
I_{CC-}	Negative supply current	vs Negative supply voltage	12
P_D	Total power dissipation	vs Free-air temperature	13

**INPUT OFFSET CURRENT
vs
FREE-AIR TEMPERATURE**

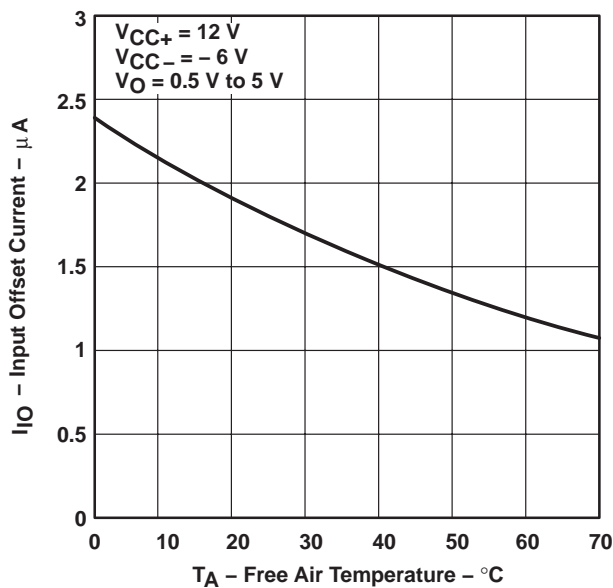


Figure 1

**INPUT BIAS CURRENT
vs
FREE-AIR TEMPERATURE**

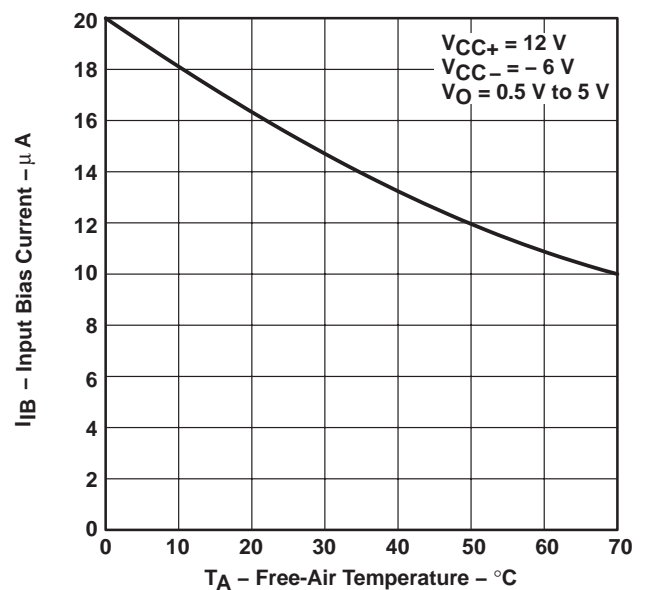


Figure 2

LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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TYPICAL CHARACTERISTICS

HIGH-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

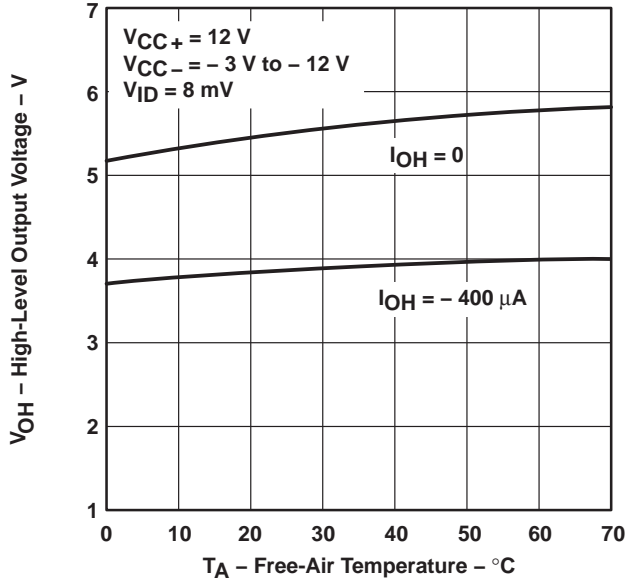


Figure 3

LOW-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

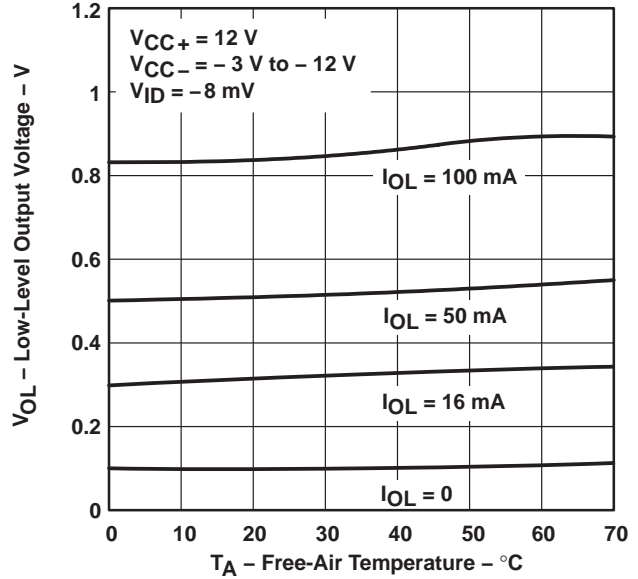


Figure 4

OUTPUT VOLTAGE
vs
DIFFERENTIAL INPUT VOLTAGE

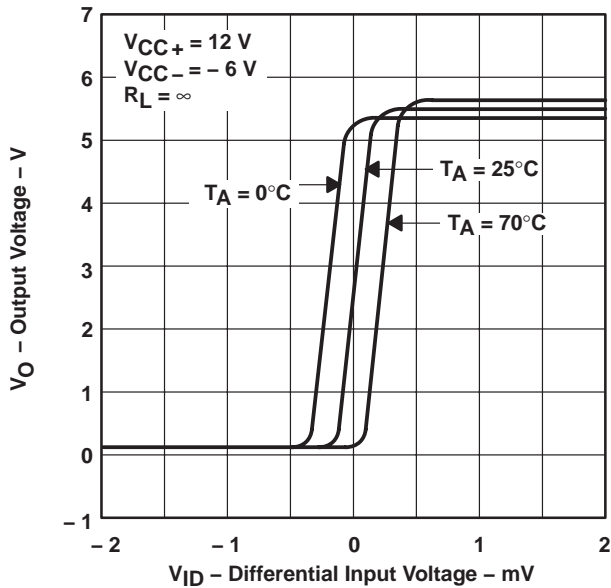


Figure 5

OUTPUT CURRENT
vs
DIFFERENTIAL INPUT VOLTAGE

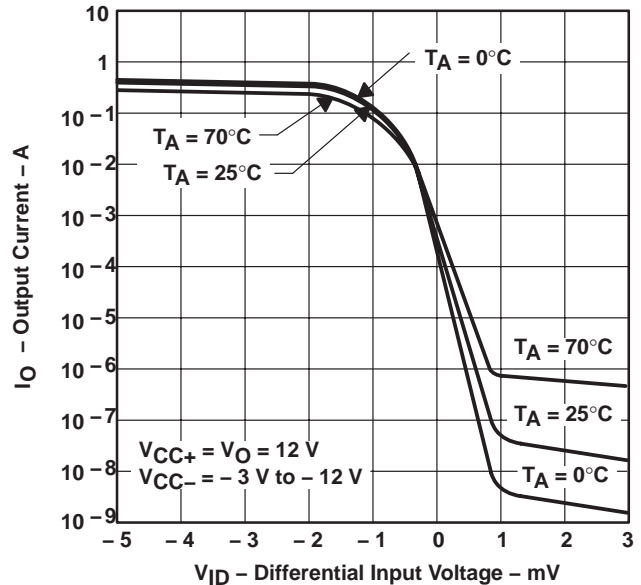


Figure 6



TYPICAL CHARACTERISTICS

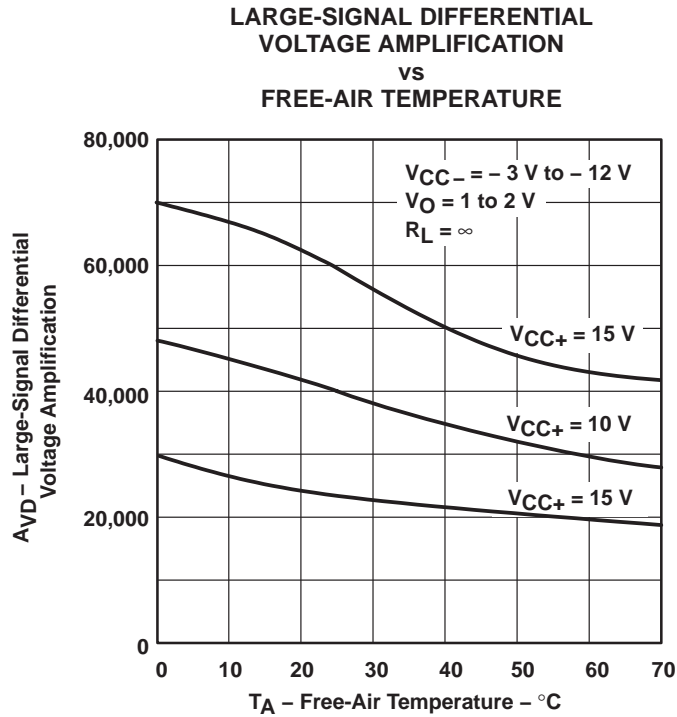
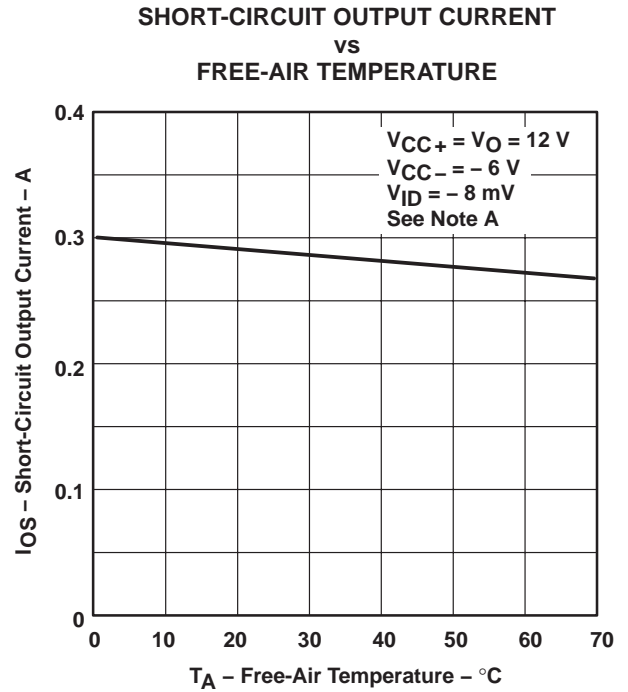


Figure 7



NOTE A: This parameter was measured using a single 5-ms pulse.

Figure 8

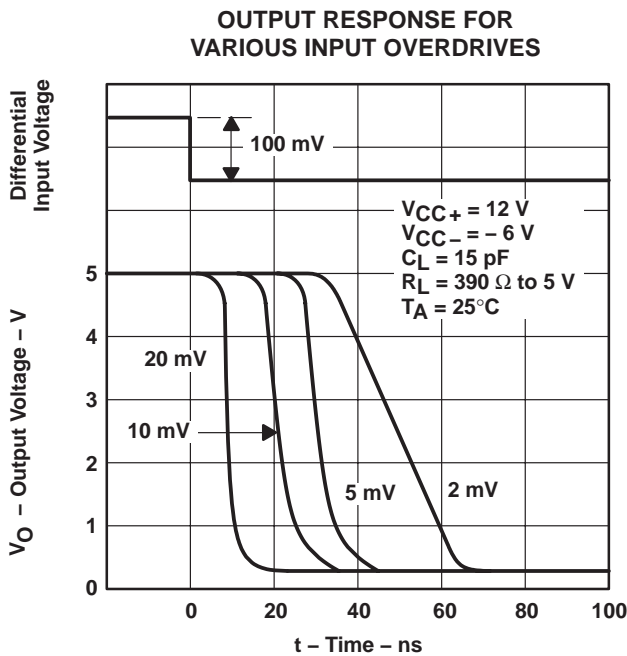


Figure 9

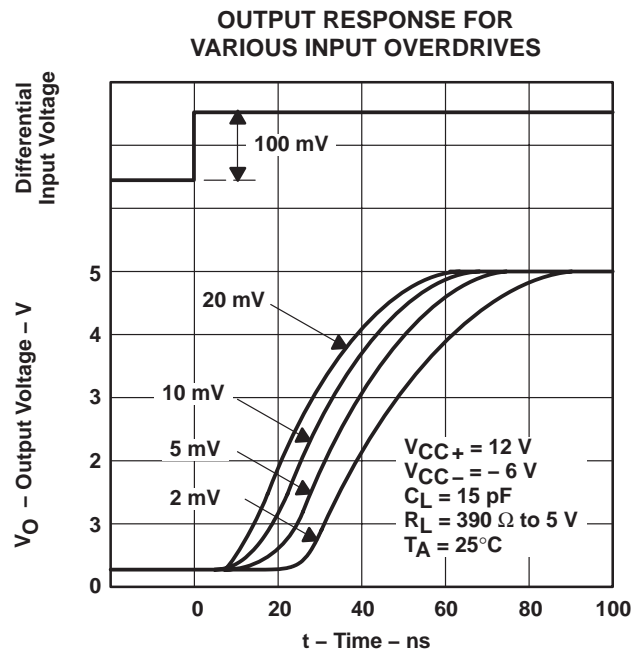


Figure 10

LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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TYPICAL CHARACTERISTICS

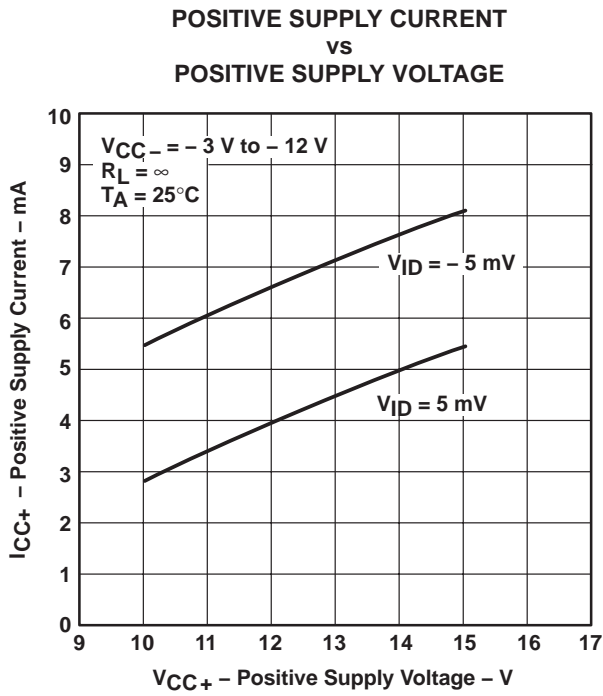


Figure 11

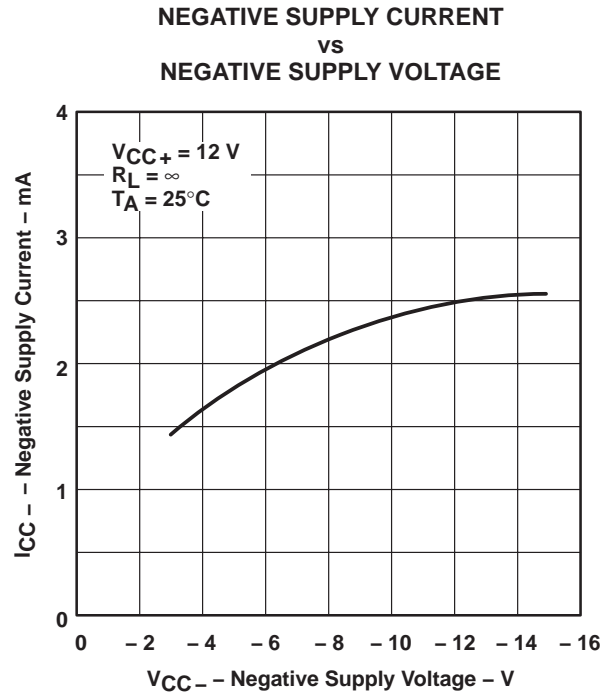


Figure 12

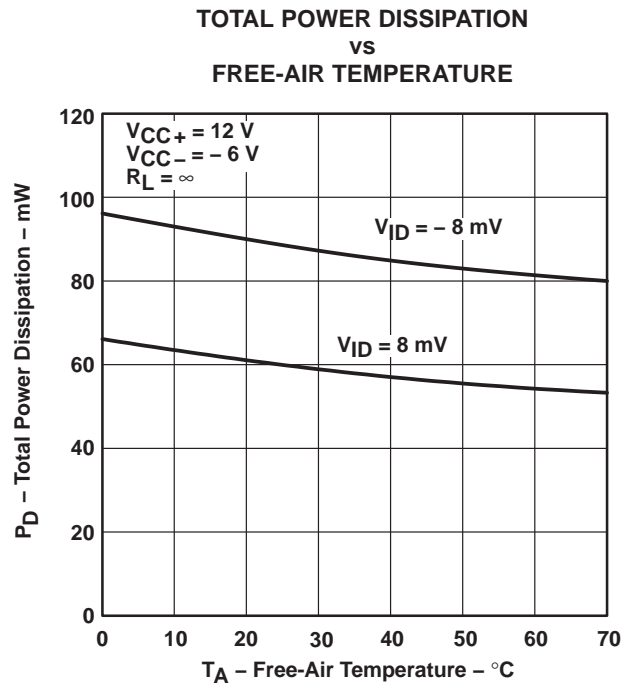


Figure 13



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM306D	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM306DE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM306DG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM306DR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM306DRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM306DRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM306P	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM306PE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM306DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM306DR	SOIC	D	8	2500	340.5	338.1	20.6

P (R-PDIP-T8)

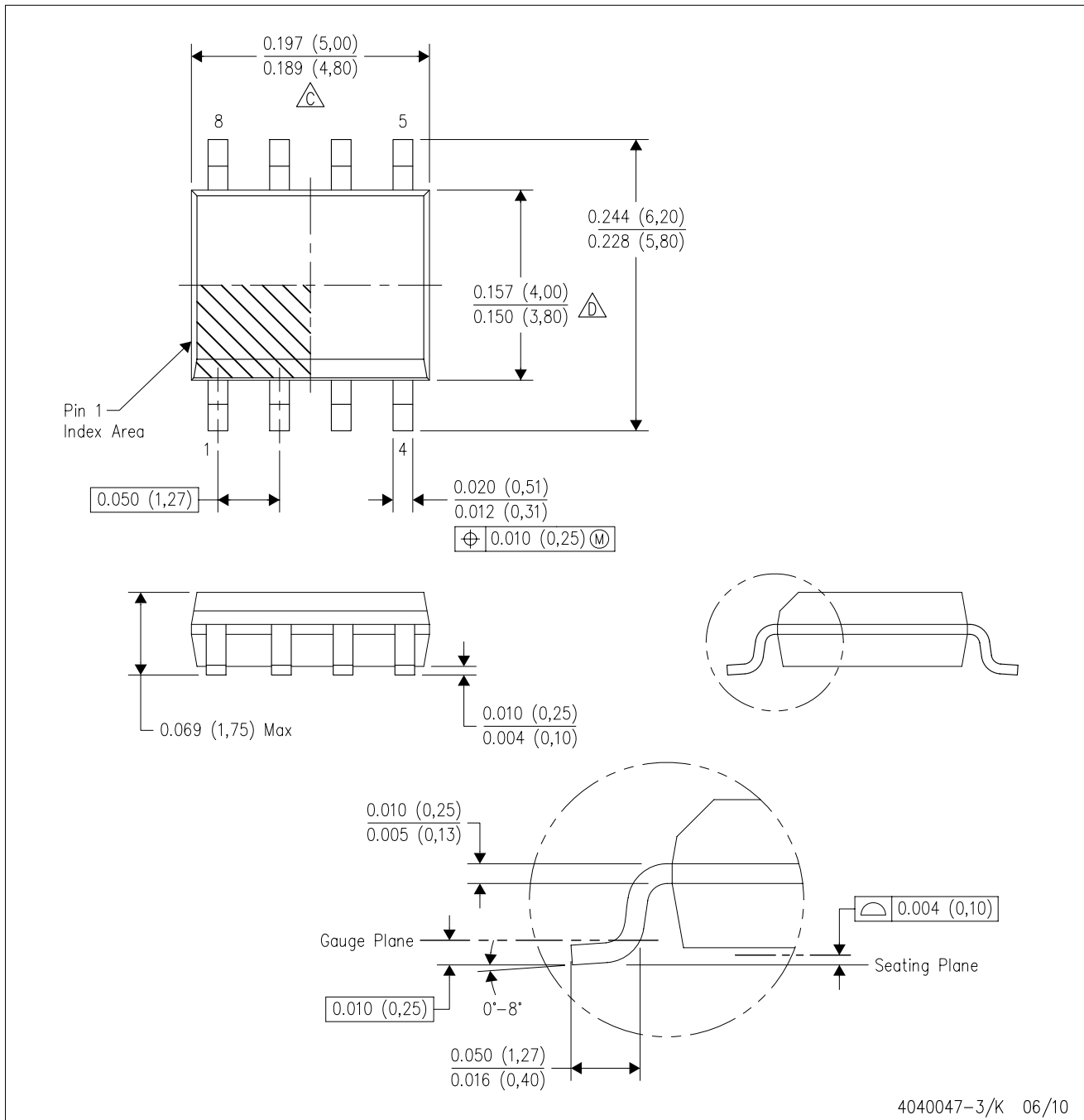
PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
 - E. Reference JEDEC MS-012 variation AA.

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